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NOTES:

MATERIAL:

HOUSING: LCP

CONTACT: COPPER ALLOY

PLATING (CONTACT): Au OVER Ni.

UL RATING: 94 V-O

SOLDER BALL: (SEE TABLE) EUTECTIC SnPb OR LEAD FREE 95.5 Sn/4Ag/0.5Cu.

SOLDER BALLS WILL NOT BE PERFECT

SHPERICAL SHAPE DUE TO REFLOW ATTACHMENT.

MATED HEIGHT EFFECTED BY CUSTOMERS PCB PAD SIZE, PLATING, SOLDER REFLOW PROFILE & SOLDER PASTE.

CONTACTS IN ROWS A, C, E, G, J, K, M, P, R AND T ARE SINGLE BEAM CONTACTS. USED AS GROUND PINS (NOTE: CONTACTS IN ROWS J & K ARE

TIED TOGETHER [COMMONED])

CONTACTS IN ROWS B, D, F, H, L, N, Q AND S ARE DUAL BEAM CONTACTS, TYPICALLY USED AS SIGNAL PINS.

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tolerances unless SEE NOTE I CUSTOMER otherwise specified ecn no. date $0.X \pm 0.3$ www.fciconnect.com projection $0.XX \pm 0.10$ GIG-Array RECEPTACLE INTERFACE 0.XXX ±0.050 RECP. ASSY. 200 SIG. POS **DESCRIPTION** GIG-Array code dr .POTTEIGER | 2007/08/15 MM product family engr D.HARPER 2007/08/15 size dwg no D.HARPER 2007/09/19 scale sheet 0081496 D. HARPER 2007/09/19 bago revision sheet

Pro/E

STATUS Released

Printed: Oct 13, 2007

22526

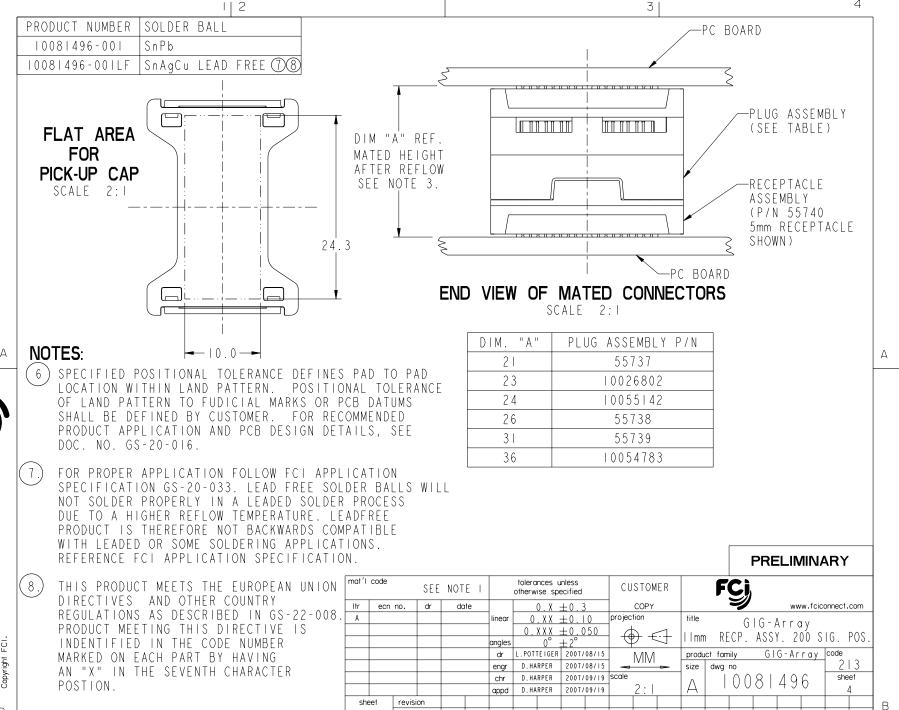
В

REV E - 2006-04-18

В

mat'l code

PDM: Rev:A



sheet

Pro/E

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STATUS: Released

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Printed: Oct 13, 2007

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PDM: Rev:A

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